

### SUBMINIATURE SOLID STATE LAMP

Part Number: AM2520SEC03

Super Bright Orange

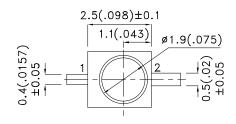
### **Features**

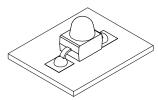
- SUBMINIA TURE PACKAGE.
- WIDE VIEWING ANGLE.
- GULL WING LEAD.
- LONG LIFE SOLID STATE RELIABILITY.
- LOW PACKAGE PROFILE.
- MOISTURE SENSITIVITY LEVEL: LEVEL 3.
- PACKAGE: 1000PCS/REEL.
- RoHS COMPLIANT.

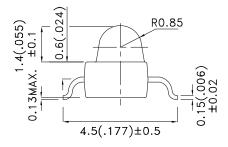
### Description

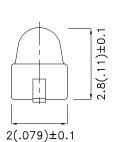
The Super Bright Orange device is made with AllnGaP (on GaAs substrate) light emitting diode chip.

### **Package Dimensions**









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### Notes:

- 1. All dimensions are in millimeters (inches).
  2. Tolerance is ±0.25(0.01") unless otherwise noted.
- 3. Lead spacing is measured where the leads emerge from the package.
- 4. Specifications are subject to change without notice.
- 5. The device has a single mounting surface. The device must be mounted according to the specifications.





SPEC NO: DSAD1257 **REV NO: V.4 DATE: JAN/15/2008** PAGE: 1 OF 5 APPROVED: WYNEC **CHECKED: Allen Liu** DRAWN: D.M.Su ERP: 1202000607

### **Selection Guide**

Part No.	Dice	Lens Type	lv (mcd) [2] @ 20mA		Viewing Angle [1]
		-	Min.	Тур.	201/2
AM2520SEC03	Super Bright Orange (AlInGaP)	WATER CLEAR	1200	2000	20°

### Notes:

- 1. θ1/2 is the angle from optical centerline where the luminous intensity is 1/2 the optical centerline value. 2. Luminous intensity/ luminous Flux: +/-15%.

### Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Device	Тур.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Super Bright Orange	610		nm	IF=20mA
λD [1]	Dominant Wavelength	Super Bright Orange	601		nm	IF=20mA
Δλ1/2	Spectral Line Half-width	Super Bright Orange	29		nm	IF=20mA
С	Capacitance	Super Bright Orange	30		pF	VF=0V;f=1MHz
VF [2]	Forward Voltage	Super Bright Orange	2	2.5	V	IF=20mA
lr	Reverse Current	Super Bright Orange		10	uA	V <sub>R</sub> =5V

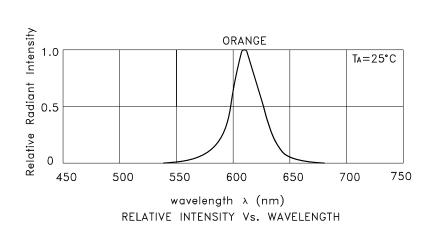
- 1.Wavelength: +/-1nm. 2. Forward Voltage: +/-0.1V.

### Absolute Maximum Ratings at TA=25°C

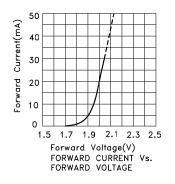
Super Bright Orange	Units	
75	mW	
30	mA	
195	mA	
5	V	
-40°C To +85°C		
-40°C To +85°C		
	75 30 195 5 -40°C To +85°C	

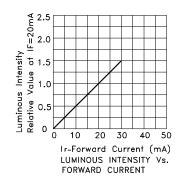
1. 1/10 Duty Cycle, 0.1ms Pulse Width.

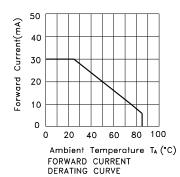
SPEC NO: DSAD1257 **REV NO: V.4** DATE: JAN/15/2008 PAGE: 2 OF 5 APPROVED: WYNEC **CHECKED: Allen Liu** DRAWN: D.M.Su ERP: 1202000607

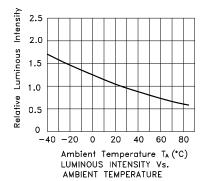


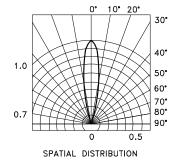
### Super Bright Orange AM2520SEC03









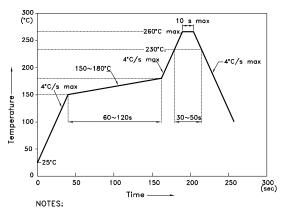


 SPEC NO: DSAD1257
 REV NO: V.4
 DATE: JAN/15/2008
 PAGE: 3 OF 5

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### AM2520SEC03

Reflow Soldering Profile For Lead-free SMT Process.



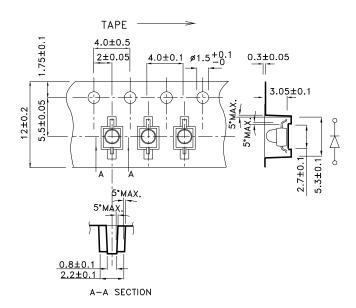
- NOTES:

  1.We recommend the reflow temperature 245°C(+/-5°C).The maximum soldering temperature should be limited to 260°C. 2.Don't cause stress to the epoxy resin while it is exposed to high temperature.
   3.Number of reflow process shall be 2 times or less.

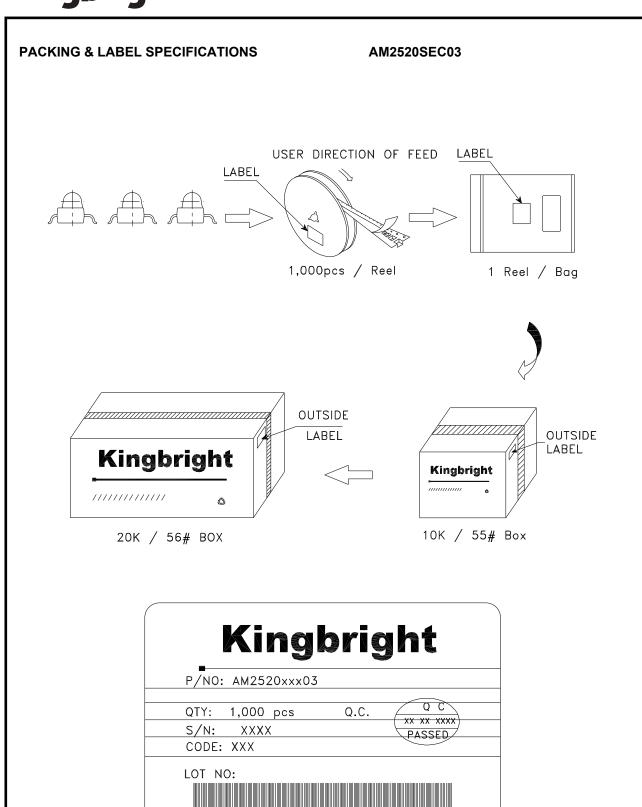
**Recommended Soldering Pattern** (Units: mm; Tolerance: ± 0.1)



**Tape Specifications** (Units: mm)



SPEC NO: DSAD1257 **REV NO: V.4 DATE: JAN/15/2008** PAGE: 4 OF 5 APPROVED: WYNEC **CHECKED: Allen Liu** DRAWN: D.M.Su ERP: 1202000607



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RoHS Compliant

PAGE: 5 OF 5 ERP: 1202000607

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**Authorized Distributor** 

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